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(54) **ELECTRODE STRUCTURE, SOLAR CELL, AND PHOTOVOLTAIC MODULE**

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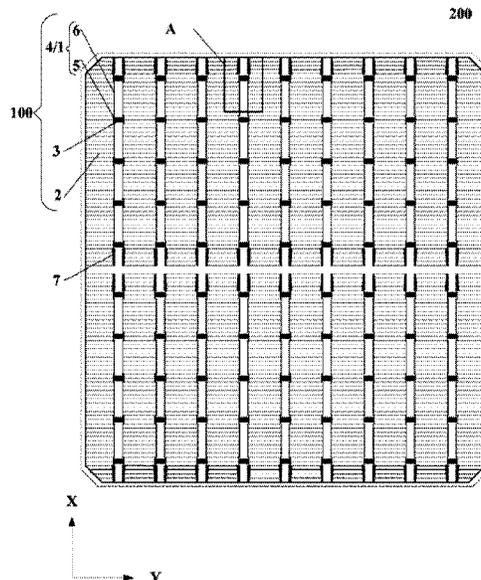
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(57) **ABSTRACT**

An electrode structure, a solar cell, and a photovoltaic module are provided. The electrode structure includes: busbars extending along a first direction and each including two sub-busbars arranged opposite to each other along a second direction intersecting with the first direction, each of the sub-busbars includes first sub-portions and second sub-portions that are spaced at intervals; fingers extending along the second direction and arranged at two sides of the busbars, the fingers are connected to the sub-busbars; and electrode pads sandwiched between the first sub-portions of the two sub-busbars and connected to the first sub-portions, the first sub-portion of at least one of the sub-busbars protrude towards a side away from the electrode pads.

**15 Claims, 4 Drawing Sheets**



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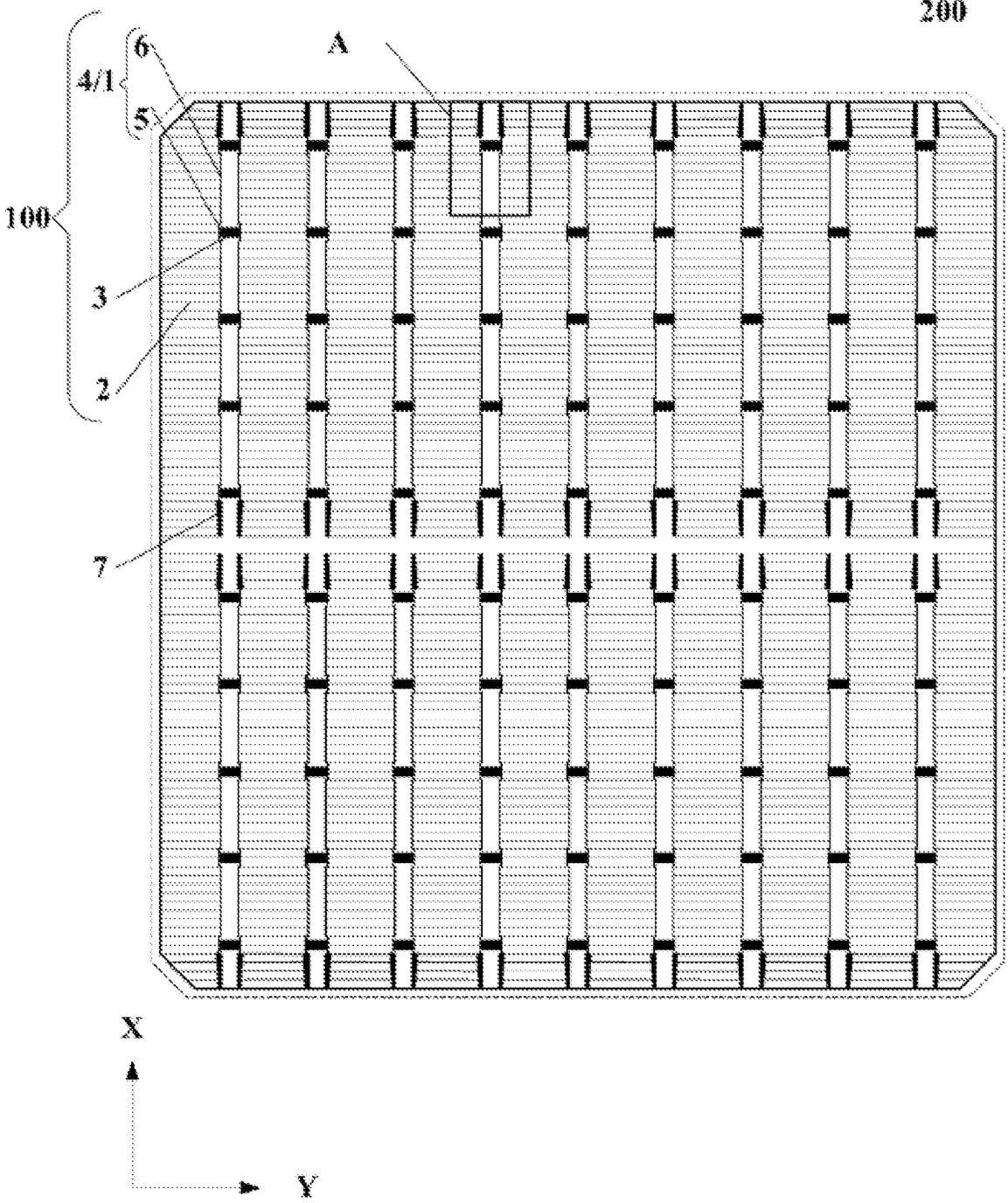


FIG. 1

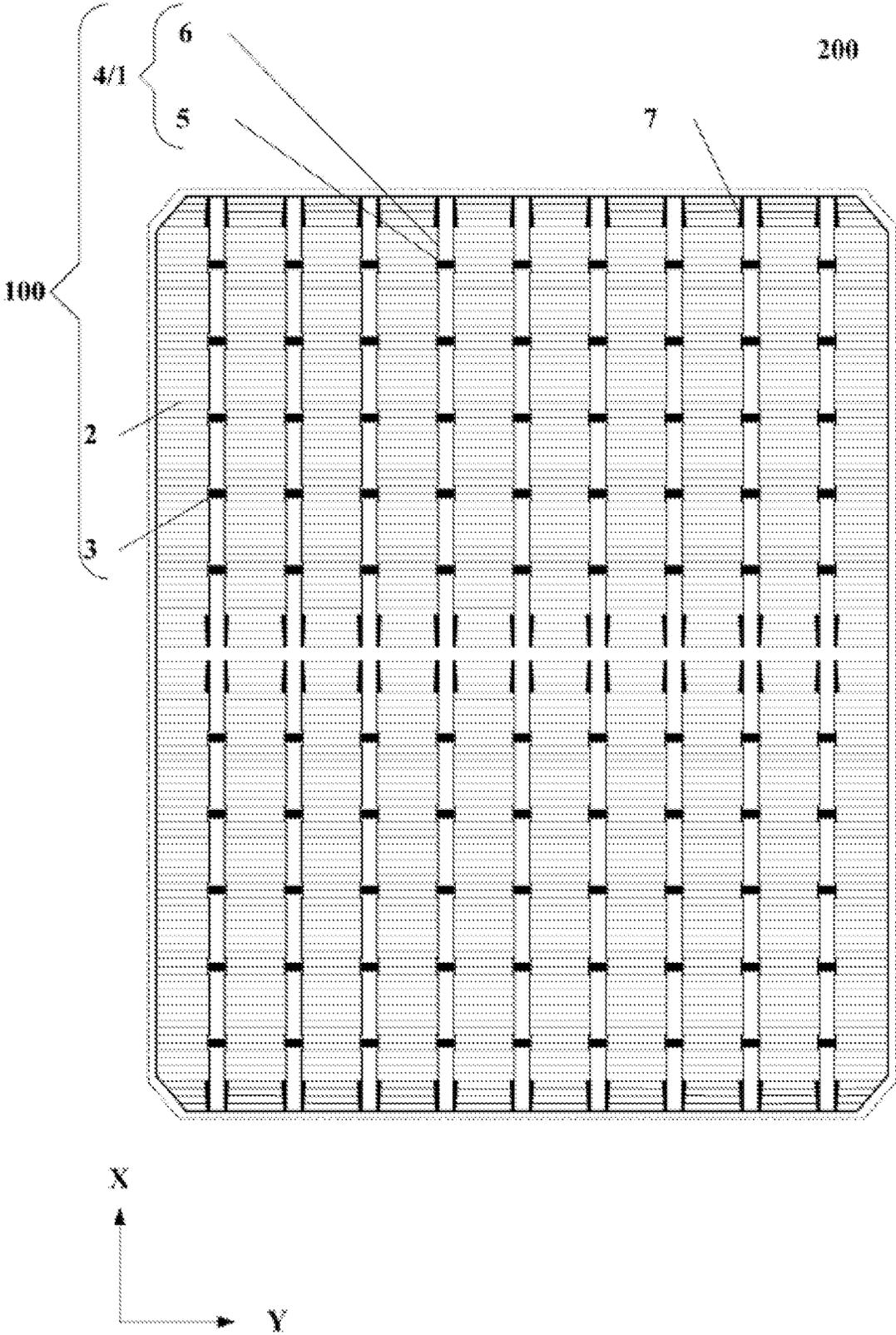


FIG. 2

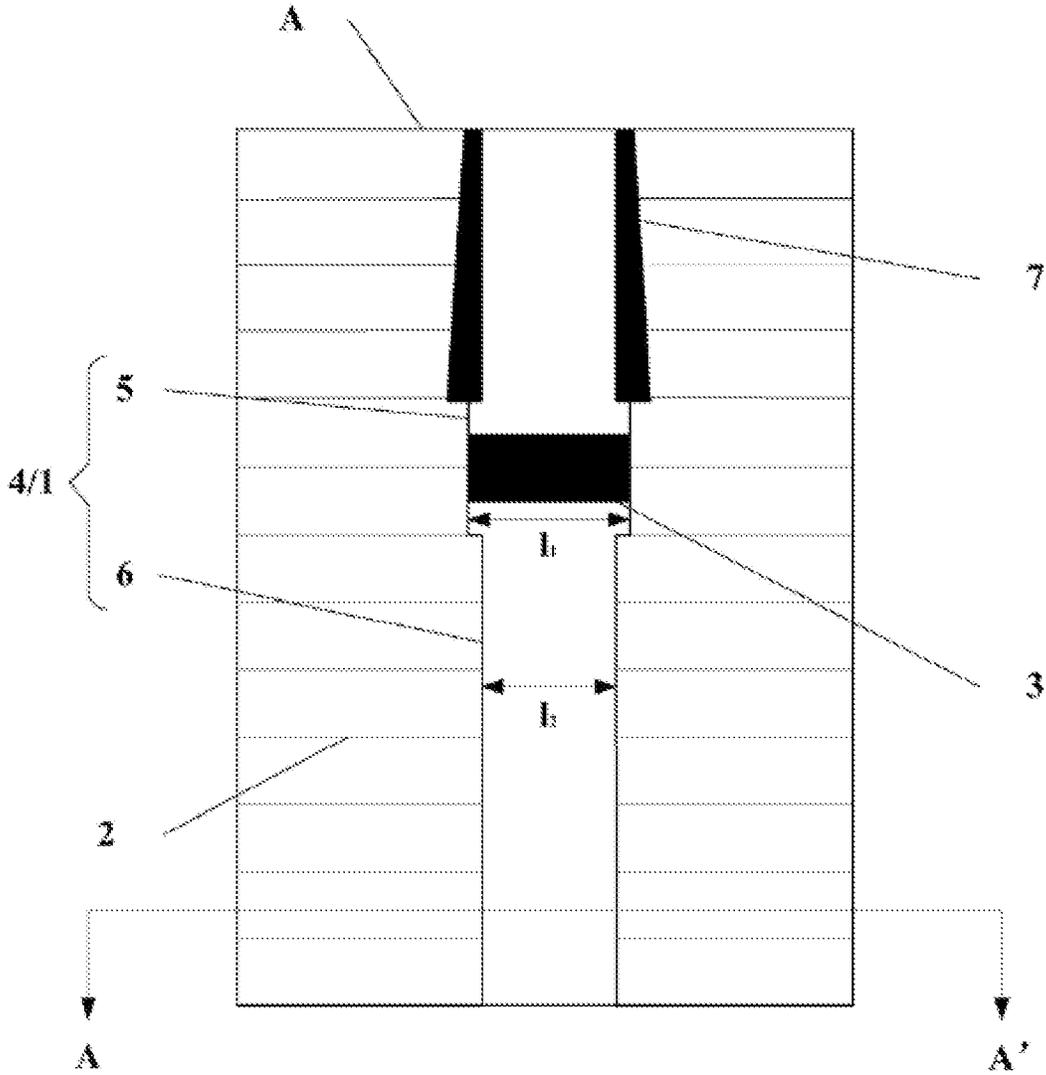


FIG. 3

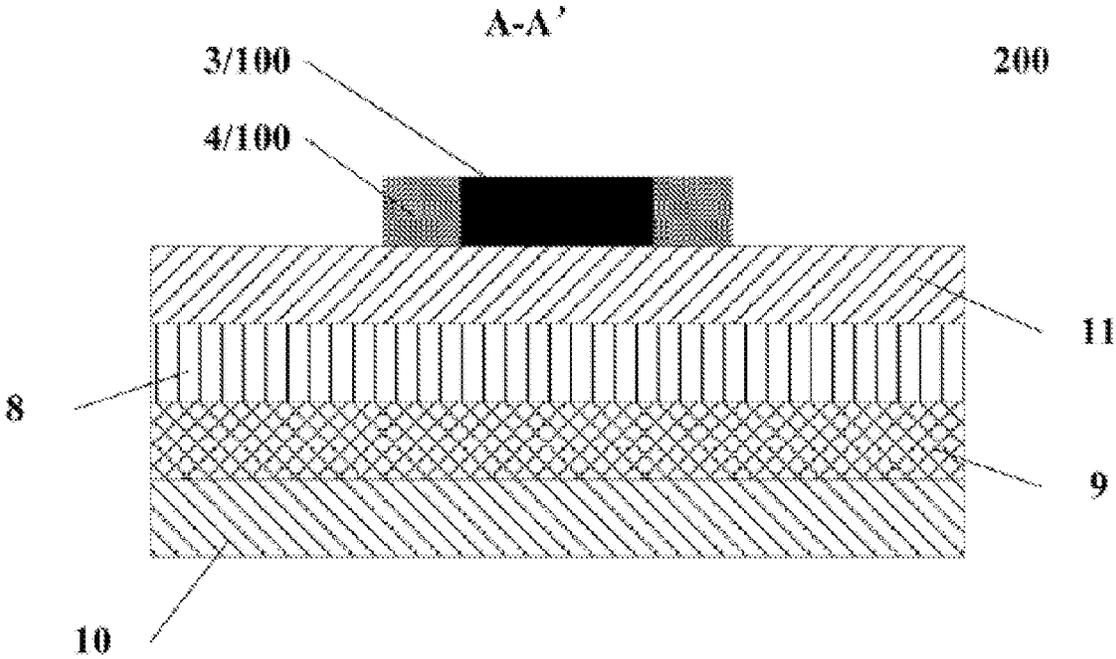


FIG. 4

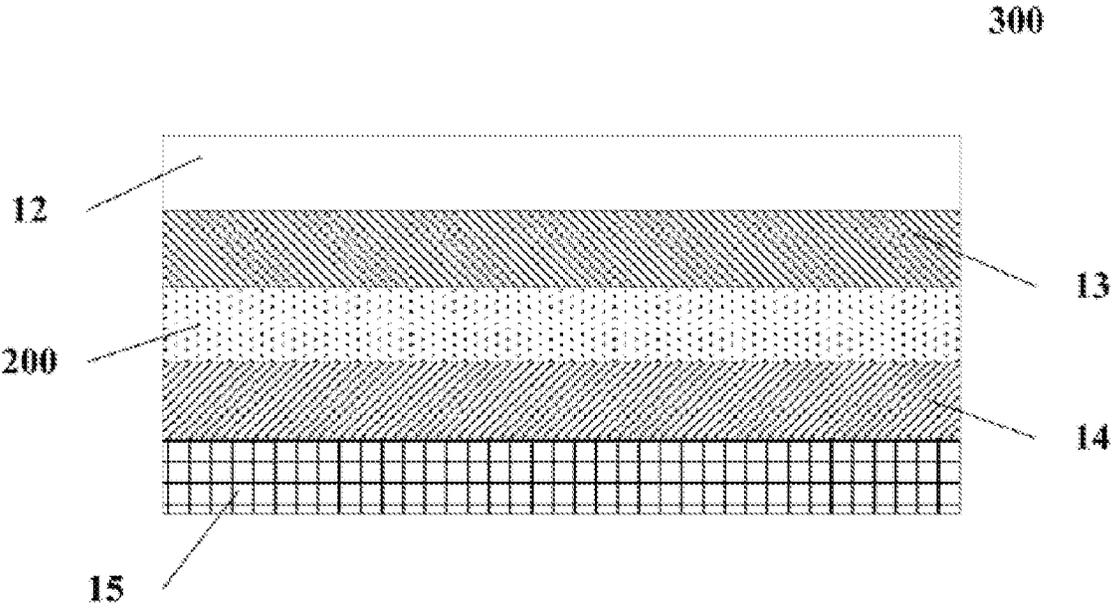


FIG. 5

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**ELECTRODE STRUCTURE, SOLAR CELL,  
AND PHOTOVOLTAIC MODULE****CROSS-REFERENCE TO RELATED  
APPLICATIONS**

The present application claims priority to Chinese Patent Application No. 202122636021.0, filed on Oct. 29, 2021, the content of which is incorporated herein by reference in its entirety.

**TECHNICAL FIELD**

The present disclosure relates to the field of photovoltaic technologies, and in particular, to an electrode structure, a solar cell, and a photovoltaic module.

**BACKGROUND**

A solar cell is a photoelectric semiconductor sheet that uses sunlight to generate power, also known as a "solar chip" or "photocell". The design of the solar cell through a plurality of busbars can reduce paths for transmitting photogenerated currents to the busbars, so as to reduce consumption caused by movement of the currents on fingers, and can also reduce an area shielded by the fingers and reduce consumption of silver paste. When the solar cell designed through the busbars forms a solar cell string through an ultra-thin solder strip, electrode pads may be in poor contact with the solder strip to result in cold soldering, which easily leads to reduction of power of the solar cell string, resulting in overall power losses of a solar module.

Therefore, it is urgent to provide an electrode structure, a solar cell, and a photovoltaic module to solve the above problems.

**SUMMARY**

In view of the above, the present disclosure provides an electrode structure, a solar cell, and a photovoltaic module.

In an aspect, the present disclosure provides an electrode structure, including: busbars extending along a first direction and each including two sub-busbars arranged opposite to each other along a second direction intersecting with the first direction, each of the sub-busbars includes first sub-portions and second sub-portions that are spaced at intervals; fingers extending along the second direction and arranged at two sides of the busbars, the fingers are connected to the sub-busbars; and electrode pads sandwiched between the first sub-portions of the two sub-busbars and connected to the first sub-portions, the first sub-portion of at least one of the sub-busbars protrude towards a side away from the electrode pads.

In another aspect, the present disclosure further provides a solar cell, including: a silicon wafer including an emitter layer on one side of the silicon wafer; a first passivation layer arranged on a side of the emitter layer away from the silicon wafer; a second passivation layer arranged on a side of the silicon wafer away from the emitter layer; and an electrode structure arranged on a side of the first passivation layer away from the silicon wafer, and/or arranged on a side of the second passivation layer away from the silicon wafer. The electrode structure includes: busbars extending along a first direction and each including two sub-busbars arranged opposite to each other along a second direction intersecting with the first direction, each of the sub-busbars includes first sub-portions and second sub-portions that are spaced at

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intervals; fingers extending along the second direction and arranged at two sides of the busbars, the fingers are connected to the sub-busbars; and electrode pads sandwiched between the first sub-portions of the two sub-busbars and connected to the first sub-portions, the first sub-portion of at least one of the sub-busbars protrude towards a side away from the electrode pads. Along the second direction, a maximum distance between adjacent first sub-portions in one of the busbars is  $l_1$ , a distance between adjacent second sub-portions in one of the busbars is  $l_2$ , where  $1.2 \leq l_1/l_2 \leq 2$ .

In a further aspect, the present disclosure further provides a photovoltaic module, including a transparent cover plate, an upper packaging layer, a lower packaging layer, and a back plate, and at least one solar cell. The solar cell includes: a silicon wafer including an emitter layer on one side of the silicon wafer; a first passivation layer arranged on a side of the emitter layer away from the silicon wafer; a second passivation layer arranged on a side of the silicon wafer away from the emitter layer; and an electrode structure arranged on a side of the first passivation layer away from the silicon wafer, and/or arranged on a side of the second passivation layer away from the silicon wafer. The electrode structure includes: busbars extending along a first direction and each including two sub-busbars arranged opposite to each other along a second direction intersecting with the first direction, each of the sub-busbars includes first sub-portions and second sub-portions that are spaced at intervals; fingers extending along the second direction and arranged at two sides of the busbars, the fingers are connected to the sub-busbars; and electrode pads sandwiched between the first sub-portions of the two sub-busbars and connected to the first sub-portions, the first sub-portion of at least one of the sub-busbars protrude towards a side away from the electrode pads. Along the second direction, a maximum distance between adjacent first sub-portions in one of the busbars is  $l_1$ , a distance between adjacent second sub-portions in one of the busbars is  $l_2$ , where  $1.2 \leq l_1/l_2 \leq 2$ .

Other features of the present disclosure and advantages thereof will become clear from the following detailed description of exemplary embodiments of the present disclosure with reference to the accompanying drawings.

**BRIEF DESCRIPTION OF DRAWINGS**

The accompanying drawings, which are incorporated in and constitute a part of the specification, illustrate embodiments of the present disclosure and, together with the description, serve to explain principles of the present disclosure.

FIG. 1 is a schematic diagram of a plane structure of a solar cell according to one or more embodiments of the present disclosure;

FIG. 2 is a schematic diagram of a plane structure of another solar cell according to one or more embodiments of the present disclosure;

FIG. 3 is an enlarged view of portion A in FIG. 1;

FIG. 4 is a sectional view taken along a direction A-A' in FIG. 3; and

FIG. 5 is a schematic structural diagram of a photovoltaic module according to one or more embodiments of the present disclosure.

**DESCRIPTION OF EMBODIMENTS**

Various exemplary embodiments of the present disclosure are now described in detail with reference to the accompanying drawings. It should be noted that, unless otherwise

stated, relative arrangement of the components and order of steps, the numerical expressions, and the values set forth in the embodiments are not intended to limit the scope of the present disclosure.

The following description of at least one exemplary embodiment is merely illustrative, and shall not be interpreted as any limitations on the present disclosure and application or use thereof.

Technologies, methods, and devices known to those of ordinary skill in the related art may not be discussed in detail, but where appropriate, such technologies, methods, and devices should be considered as part of the specification.

In all the examples shown and discussed herein, any specific value should be construed as merely illustrative and not as any limitation. Therefore, other examples of exemplary embodiments may have different values.

It should be noted that similar reference signs denote similar terms in the accompanying drawings, and therefore, once an item is defined in a drawing, there is no need for further discussion in the accompanying drawings.

Referring to FIG. 1, FIG. 1 is a schematic diagram of a plane structure of a solar cell 200 according to one or more embodiments of the present disclosure.

An electrode structure 100 according to some embodiments includes busbars 1, fingers 2, and electrode pads 3.

The busbars 1 extend along a first direction X, each of the busbars 1 includes two sub-busbars 4 arranged opposite to each other along a second direction Y, each of the sub-busbars 4 includes first sub-portions 5 and second sub-portions 6 that are spaced from each other, the electrode pads 3 are sandwiched between the first sub-portions 5 of the two sub-busbars 4 and connected to the first sub-portions 5, the first sub-portions 5 of at least one of the sub-busbars 4 protrude towards the side away from the electrode pads 3, and the second direction Y intersects with the first direction X. Along the second direction, a maximum distance between adjacent first sub-portions 5 in one of the busbars 1 is  $l_1$ , a distance between adjacent second sub-portions 6 in one of the busbars 1 is  $l_2$ , where  $1.2 \leq l_1/l_2 \leq 2$ .

The fingers 2 extend along the second direction Y and are arranged on two sides of the busbar 1 and connected to the sub-busbars 4.

It is to be noted that FIG. 1 merely illustrates that each first sub-portion 5 protrudes towards the side away from the electrode pad 3. Alternatively, in one busbar 1, the first sub-portions 5 of only one sub-busbar 4 protrude towards the side away from the electrode pad 3. Alternatively, in one busbar 1, the first sub-portions 5 of two sub-busbars 4 protruding towards the side away from the electrode pads 3 are alternately arranged. Details are not described herein. FIG. 1 illustrates that lengths of the second sub-portions 6 are all equal along the first direction X. In practical applications, a distance between two adjacent first sub-portions 5 of one sub-busbar 4 may be adjusted through the lengths of the second sub-portions 6 along the first direction X. In addition, numbers of the busbars 1, the fingers 2, and the electrode pads 3 in FIG. 1 are only illustrative, which may be adjusted as required.

It may be understood that the fingers 2 have the function of collecting carriers and transmitting the carriers to the busbars 1, the busbars 1 conduct the collected currents to the electrode pads 3, and the electrode pads 3 are connected to the solder strip to conduct the current out. The busbars 1 and the fingers 2 are integrally manufactured by screen printing, or the busbars 1 and the fingers 2 are printed separately, which is not limited herein. The busbars 1 and the fingers 2 are generally made of silver, but are not limited thereto,

which may also be made of aluminum or other materials as required. The busbars 1 each include two sub-busbars 4, so that the solder strip can be limited between the two sub-busbars 4 of the busbar 1 and the solder strip can directly contact the electrode pads 3, which reduces micro cracks during the soldering of the solder strip with the electrode pads 3 and can reduce the repair rate caused by the micro cracks during the soldering. Upon testing, the repair rate is reduced by 39%, and a layer repair rate is reduced from 16.93% to 10.31%.

Compared with the related art, the electrode structure 100 according to this embodiment has at least the following beneficial effects.

The busbars 1 extend along a first direction X, each of the busbars 1 includes two sub-busbars 4 arranged opposite to each other along a second direction Y, and each of the sub-busbars 4 includes first sub-portions 5 and second sub-portions 6 that are spaced from each other. When a solder strip is assembled, the solder strip is limited between the two sub-busbars 4 of one of the busbars 1 and can directly contact the electrode pads 3, which helps to improve soldering tension between the solder strip and the electrode pads 3 and can also reduce the probability of micro cracks during assembly. The electrode pads 3 are sandwiched between the first sub-portions 5 of the two sub-busbars 4 and connected to the first sub-portions 5, the first sub-portions 5 of at least one of the sub-busbars 4 protrude towards the side away from the electrode pads 3, and the second direction Y intersects with the first direction X. Since the electrode pads 3 are connected to the first sub-portions 5 and the first sub-portions 5 are expanded, a soldering window is widened. Along a direction perpendicular to a plane where the electrode structure 100 is located, differences exist between heights of the sub-busbars 4 and heights of the electrode pads 3, which may not affect the connection between the solder strip and the electrode pads 3. Even if the solder strip deviates slightly, the solder strip may be at least partially connected to the electrode pads 3, which effectively avoids cold soldering during the soldering of the electrode pads 3 with the solder strip. Moreover, the range is appropriately defined as  $1.2 \leq l_1/l_2 \leq 2$ . When  $l_1/l_2$  is less than 1.2, in one of the busbars 1, a difference between the maximum distance between the adjacent first sub-portions 5 and the distance between the adjacent second sub-portions 6 is small, which is not conducive to the manufacturing and does not evidently avoid the cold soldering. When  $l_1/l_2$  is greater than 2, silver paste may be wasted, and a double-side performance of a solar cell using the electrode structure 100 is affected.

In some embodiments, referring to FIG. 1 and FIG. 2, FIG. 2 is a schematic diagram of a plane structure of another solar cell 200 according to one or more embodiments of the present disclosure. Connecting end portions 7 are arranged at two ends of the sub-busbars 4, the connecting end portions 7 are connected to the first sub-portions 5. In the connecting end portions 7 and the first sub-portions 5 that are connected, widths of the connecting end portions 7 in the second direction Y gradually decrease along a direction from the first sub-portions 5 pointing to the connecting end portions 7.

Additionally or alternatively, the connecting end portions 7 are connected to the second sub-portions 6, and in the connecting end portions 7 and the second sub-portions 6 that are connected, widths of the connecting end portions 7 in the second direction Y gradually decrease along a direction from the second sub-portions 6 pointing to the connecting end portions 7.

It is to be noted that FIG. 1 illustrates that two ends of the connecting end portions 7 are connected to the first sub-portions 5, and FIG. 2 illustrates that the two ends of the connecting end portions 7 are connected to the second sub-portions 6. Alternatively, the connecting end portions 7 have one end connected to the first sub-portions 5 and the other end connected to the second sub-portions 6. Details are not described herein. Orthographic projections of the connecting end portions 7 in the direction of the plane where the electrode structure 100 is located may be trapezoidal or triangular. FIG. 1 and FIG. 2 only illustrate that all the electrode pads 3 are rectangles of a same size. During practical arrangement, in a plurality of electrode pads 3 sequentially arranged along the first direction X, sizes of the electrode pads 3 in the head and the electrode pads 3 in the tail are slightly larger than those of the electrode pads 3 in the middle part, which can prevent deviation of the solder strip and can be adjusted according to actual requirements. Moreover, FIG. 1 and FIG. 2 only illustrate that the solar cell using the electrode structure 100 according to embodiments of the present disclosure is divided into two half-cut cells, which may certainly also be designed as multiple cut cells according to actual requirements and is not limited herein.

It may be understood that, along the first direction X, when the sub-busbars 4 between two adjacent electrode pads 3 conduct the current, the current may be conducted to either of the two electrode pads 3. Along the first direction X, the sub-busbars 4 between the electrode pads 3 in the head and edges of the electrode structure 100 can only conduct the current to the electrode pads 3 in the head. Similarly, along the first direction X, the sub-busbars 4 between the electrode pads 3 in the tail and the edges of the electrode structure 100 can only conduct the current to the electrode pads 3 in the tail. Therefore, widths of the connecting end portions 7 arranged at two ends of the sub-busbars 4 along the second direction Y are designed as gradually varying with a gradient, which can help to collect currents at the edges of the electrode structure 100, improve conductivity efficiency, and alleviate blackening at the edges of the electrode structure 100.

In some embodiments, referring to FIG. 3, FIG. 3 is an enlarged view of portion A in FIG. 1. Distances between the connecting end portions 7 of the two sub-busbars 4 in one of the busbars 1 are equal along the second direction Y.

It may be understood that, in the two sub-busbars 4 of one busbar 1, a projection of a region between two opposite connecting end portions 7 in the direction of the plane where the electrode structure 100 is located is rectangular. A solder strip is arranged in the rectangular region, so that the solder strip can be ensured to be located between the two sub-busbars 4 of one busbar 1, thereby preventing cold soldering caused by height differences between the connecting end portions 7 and the electrode pads 3 due to the connection of the solder strip with the connecting end portions 7.

In some embodiments, the distances between the connecting end portions 7 of the two sub-busbars 4 in one of the busbars 1 range from 0.5 mm to 3.0 mm along the second direction Y.

It is to be noted that, along the second direction Y, in one of the busbars 1, when the distances between the connecting end portions 7 of the two sub-busbars 4 are less than 0.5 mm, the requirement on the soldering is relatively high. When the distances between the connecting end portions 7 of the two sub-busbars 4 are greater than 3.0 mm, transfer efficiency may be affected. In the present disclosure, the distances between the connecting end portions 7 of the two sub-

busbars 4 in one of the busbars 1 ranging from 0.5 mm to 3.0 mm can meet the requirement on the soldering and can also ensure the transfer efficiency.

It may be understood that the distances between the connecting end portions 7 of the two sub-busbars 4 in one of the busbars 1 along the second direction Y depend on the width of the solder strip along the second direction Y, which may be adjusted based on actual requirements. For example, the distances between the connecting end portions 7 of the two sub-busbars 4 in one of the busbars 1 range from 0.5 mm to 3.0 mm along the second direction Y, but is not limited thereto.

In some embodiments, along the second direction Y, widths of the sides of the connecting end portions 7 away from the electrode pads 3 are greater than or equal to 0.1 mm, and widths of the sides of the connecting end portions 7 close to the electrode pads 3 are less than or equal to 2 mm.

It is to be noted that the connecting end portions 7 are generally formed by paste printing, but in this way, it is difficult to make the widths of the sides of the connecting end portions 7 away from the electrode pads 3 less than 0.1 mm along the second direction Y. If the widths of the sides of the connecting end portions 7 close to the electrode pads 3 are greater than 2 mm along the second direction Y, a double-side performance of the solar cell using the electrode structure 100 may be affected. In the present disclosure, along the second direction Y, widths of the sides of the connecting end portions 7 away from the electrode pads 3 are greater than or equal to 0.1 mm, and widths of the sides of the connecting end portions 7 close to the electrode pads 3 are less than or equal to 2 mm, which can satisfy printing requirements and can also ensure the double-side performance of the solar cell using the electrode structure 100.

It may be understood that shapes and sizes of the connecting end portions 7 are designed according to sizes of the busbars 1, which may vary as the widths of the busbars 1 along the second direction Y change. When the widths of the sides of the connecting end portions 7 away from the electrode pads 3 along the second direction Y are determined, since the widths of the connecting end portions 7 along the second direction Y are designed as gradually varying with a gradient, the widths of the sides of the connecting end portions 7 close to the electrode pads 3 along the second direction Y are greater than the widths of the sides of the connecting end portions 7 away from the electrode pads 3 along the second direction Y. For example, along the second direction Y, widths of the sides of the connecting end portions 7 away from the electrode pads 3 are greater than or equal to 0.1 mm, and widths of the sides of the connecting end portions 7 close to the electrode pads 3 are less than or equal to 2 mm, but is not limited thereto.

In some embodiments, at least 3 electrode pads 3 are provided.

It is to be noted that the number of the electrode pads 3 is generally even, such as 4, 6, or 8, but the specific setting may be adjusted according to an actual requirement.

It may be understood that a plurality of electrode pads 3 may be provided. If the electrode structure 100 has a plurality of electrode pads 3, current conduction is more uniform, which is conducive to improving the efficiency of the electrode structure 100. At the same time, electroluminescence (EL) of the module is brighter, which is conducive to improving power of the module.

In some embodiments, still referring to FIG. 3, the two sub-busbars 4 of one of the busbars 1 are symmetrically arranged. The maximum distance  $l_1$  between the adjacent first sub-portions 5 ranges from 1.2 mm to 1.8 mm along the

second direction Y. The distance  $l_2$  between the adjacent second sub-portions **6** ranges from 0.9 mm to 1.5 mm along the second direction Y.

It is to be noted that, if the maximum distance  $l_1$  between the adjacent first sub-portions **5** is less than 1.2 mm along the second direction Y, the widths of the electrode pads **3** along the second direction Y may be reduced, and the contact area between the electrode pads **3** and the solder strip may be reduced. If the maximum distance  $l_1$  between the adjacent first sub-portions **5** is greater than 1.8 mm along the second direction Y, the widths of the electrode pads **3** along the second direction Y may be increased, resulting in unnecessary waste. Along the second direction Y, the distance **12** between the adjacent second sub-portions **6** is less than the maximum distance  $l_1$  between the adjacent first sub-portions **5**.

It may be understood that the maximum distance  $l_1$  between the adjacent first sub-portions **5** ranges from 1.2 mm to 1.8 mm along the second direction Y and the distance **12** between the adjacent second sub-portions **6** ranges from 0.9 mm to 1.5 mm along the second direction Y, which facilitates good soldering of the electrode pads **3** with the solder strip.

In some embodiments, along the first direction X, the electrode pads **3** are in contact with the sub-busbars **4**, and a length of a contact region ranges from 0.5 mm to 5.0 mm.

It is to be noted that, when the length of the contact region is less than 0.5 mm along the first direction X, it is not conducive to the soldering. When the length of the contact region is greater than 5.0 mm along the first direction X, silver paste is wasted, and the region is excessively shielded. In the present disclosure, along the first direction X, the electrode pads **3** is in contact with the sub-busbars **4**, and a length of a contact region ranging from 0.5 mm to 5.0 mm can facilitate the soldering and can also save the amount of silver paste and reduce the costs.

It may be understood that, when the solder strip is soldered with the electrode pads **3**, the electrode pads **3** match the first sub-portions **5**, and the lengths of the electrode pads **3** along the first direction X are less than or equal to the lengths of the first sub-portions **5** along the first direction X. In the present disclosure, the length of the contact region ranges from 0.5 mm to 5.0 mm along the first direction X, which can ensure effectiveness of the contact. The range is not limited thereto, which may be adjusted as required.

In some embodiments, widths of the sub-busbars **4** range from 0.2 mm to 0.6 mm along the second direction Y.

It is to be noted that, along the second direction Y, when the widths of the sub-busbars **4** are less than 0.2 mm, efficiency of current conduction is affected. When the widths of the sub-busbars **4** are greater than 0.6 mm, the efficiency of current conduction is improved, but the double-side performance of the solar cell using the electrode structure **100** in this situation may be reduced. In the present disclosure, widths of the sub-busbars **4** ranging from 0.2 mm to 0.6 mm along the second direction Y can satisfy efficiency of current transfer of the sub-busbars **4** and can also ensure the double-side performance of the solar cell using the electrode structure **100** described as above.

It may be understood that, in the related art, the widths of the busbars **1** along the second direction Y range from 1.0 mm to 1.5 mm. Widths of the busbars **1** according to the present disclosure along the second direction Y range from 0.4 mm to 1.2 mm, so that the widths of the busbars **1** according to the present disclosure along the second direction Y are narrower than those in the related art, which can

reduce the amount of silver paste, reduce shielded regions, and increase the double-side performance of the solar cell using the electrode structure **100** in this embodiment. In that the present disclosure, widths of the sub-busbars **4** range from 0.2 mm to 0.6 mm along the second direction Y, and the widths of the busbars **1** along the second direction Y may also be set to be wider than or equal to those in the related art according to an actual requirement, which is not limited herein.

The present disclosure provides a solar cell **200**. Referring to FIG. **4**, FIG. **4** is a sectional view taken along a direction A-A' in FIG. **3**.

The solar cell **200** according to some embodiments includes: a silicon wafer **8**, the silicon wafer **8** is provided with an emitter layer **9** on one side; a first passivation layer **10** arranged on the side of the emitter layer **9** away from the silicon wafer **8**; a second passivation layer **11** arranged on the side of the silicon wafer **8** away from the emitter layer **9**; and an electrode structure **100** arranged on the side of the first passivation layer **10** away from the silicon wafer **8**, and/or arranged on the side of the second passivation layer **11** away from the silicon wafer **8**. The electrode structure **100** is the electrode structure **100** described above.

It is to be noted that FIG. **4** only illustrates that the solar cell **200** is a Passivated Emitter and Rear Cell (PERC) double-sided cell. The electrode structure **100** is arranged on the side of the second passivation layer **11** away from the silicon wafer **8**. However, the electrode structure **100** may be arranged only on the side of the first passivation layer **10** away from the silicon wafer **8** or only on the side of the second passivation layer **11** away from the silicon wafer **8**, or the electrode structure **100** is arranged on both the side of the first passivation layer **10** away from the silicon wafer **8** and the side of the second passivation layer **11** away from the silicon wafer **8**, thereby increasing the double-side performance of the solar cell **200**. The solar cell **200** may also be an N-type Tunnel Oxide Passivated Contact (TOP-Con) solar cell or other types of solar cells. The N-type TOPCon solar cell includes a first passivation layer **10**, an emitter layer **9**, a silicon wafer **8**, an ultra-thin oxide layer, a doped polysilicon layer, and a back passivation layer.

It may be understood that the solar cell **200** according to some embodiments of the present disclosure has the beneficial effects of the electrode structure **100** according to embodiments of the present disclosure. Details can be obtained with reference to the description of the electrode structure **100** in the above embodiments, which are not described herein.

The present disclosure further provides a photovoltaic module **300**. Referring to FIG. **5**, FIG. **5** is a schematic structural diagram of a photovoltaic module **300** according to one or more embodiments of the present disclosure.

The photovoltaic module **300** includes a transparent cover plate **12**, an upper packaging layer **13**, a solar cell **200**, a lower packaging layer **14**, and a back plate **15**. The solar cell **200** is the solar cell **200** described above. It may be understood that the photovoltaic module **300** according to the present disclosure has the beneficial effects of the solar cell **200** according to the present disclosure. Details can be obtained with reference to the description of the solar cell **200** in the above embodiments, which are not described herein.

As can be known from the above embodiments, the electrode structure, the solar cell, and the photovoltaic module according to the present disclosure achieve at least the following beneficial effects.

The busbars extend along a first direction, each of the busbars includes two sub-busbars arranged opposite to each other along a second direction, and each of the sub-busbars includes first sub-portions and second sub-portions that are spaced from each other. When a solder strip is assembled, the solder strip is limited between the two sub-busbars of one of the busbars and can directly contact the electrode pads, which helps to improve soldering tension between the solder strip and the electrode pads and can also reduce the probability of micro cracks during assembly. The electrode pads are sandwiched between the first sub-portions of the two sub-busbars and connected to the first sub-portions, the first sub-portions of at least one of the sub-busbars protrude towards the side away from the electrode pads, and the second direction intersects with the first direction. Since the electrode pads are connected to the first sub-portions and the first sub-portions are expanded, a soldering window is widened. Along the direction perpendicular to the plane where the electrode structure is located, differences exist between heights of the sub-busbars and heights of the electrode pads, which may not affect the connection between the solder strip and the electrode pads. Even if the solder strip deviates slightly, the solder strip may be at least partially connected to the electrode pads, which effectively avoids cold soldering during the soldering of the electrode pads with the solder strip. Moreover, the range of  $l_1/l_2$  is set as  $1.2 \leq l_1/l_2 \leq 2$ , to avoid the situations when  $l_1/l_2$  is less than 1.2, in one of the busbars, a difference between the maximum distance between the adjacent first sub-portions and the distance between the adjacent second sub-portions is small, which is not conducive to the manufacturing and does not evidently avoid the cold soldering; and when  $l_1/l_2$  is greater than 2, silver paste may be wasted, and a double-side performance of a solar cell using the electrode structure is affected.

Although some embodiments of the present disclosure have been described in detail through examples, it should be understood by those skilled in the art that the above examples are for illustrative purposes only and not intended to limit the scope of the present disclosure. It should be understood by those skilled in the art that the above embodiments can be modified without departing from the scope and spirit of the disclosure. The scope of the present disclosure is defined by the appended claims.

What is claimed is:

**1.** An electrode structure, comprising:

busbars extending along a first direction and each including two sub-busbars arranged opposite to each other along a second direction intersecting with the first direction, wherein each of the sub-busbars includes first sub-portions and second sub-portions that are spaced at intervals,

fingers extending along the second direction and arranged at two sides of the busbars, wherein the fingers are connected to the sub-busbars, and

electrode pads sandwiched between the first sub-portions of the two sub-busbars and connected to the first sub-portions, wherein the first sub-portion of at least one of the sub-busbars protrude towards a side away from the electrode pads,

wherein connecting end portions are provided at two ends of each of the sub-busbars, the connecting end portions are connected to the first sub-portions, and in the connecting end portions and the first sub-portions that are connected, widths of the connecting end portions in

the second direction gradually decrease along a direction from the first sub-portions pointing to the connecting end portions; and/or

the connecting end portions are connected to the second sub-portions, and in the connecting end portions and the second sub-portions that are connected, widths of the connecting end portions in the second direction gradually decrease along a direction from the second sub-portions pointing to the connecting end portions.

**2.** The electrode structure according to claim 1, wherein along the second direction, distances between the connecting end portions of the two sub-busbars in one of the busbars are equal.

**3.** The electrode structure according to claim 2, wherein along the second direction, the distances between the connecting end portions of the two sub-busbars in one of the busbars range from 0.5 mm to 3.0 mm.

**4.** The electrode structure according to claim 1, wherein along the second direction, widths of sides of the connecting end portions away from the electrode pads are greater than or equal to 0.1 mm, and widths of sides of the connecting end portions close to the electrode pads are less than or equal to 2 mm.

**5.** The electrode structure according to claim 1, wherein the two sub-busbars of one of the busbars are symmetrically arranged;

along the second direction, a maximum distance between adjacent first sub-portions ranges from 1.2 mm to 1.8 mm, and

along the second direction, a distance between adjacent second sub-portions ranges from 0.9 mm to 1.5 mm.

**6.** The electrode according to claim 1, wherein along the first direction, the electrode pads are in contact with the sub-busbars, and a length of a contact region ranges from 0.5 mm to 5.0 mm.

**7.** The electrode according to claim 1, wherein along the second direction, widths of the sub-busbars range from 0.2 mm to 0.6 mm.

**8.** A solar cell, comprising:

a silicon wafer including an emitter layer on one side of the silicon wafer;

a first passivation layer arranged on a side of the emitter layer away from the silicon wafer;

a second passivation layer arranged on a side of the silicon wafer away from the emitter layer; and

an electrode structure arranged on a side of the first passivation layer away from the silicon wafer, and/or arranged on a side of the second passivation layer away from the silicon wafer,

wherein the electrode structure comprises:

busbars extending along a first direction and each including two sub-busbars arranged opposite to each other along a second direction intersecting with the first direction, wherein each of the sub-busbars includes first sub-portions and second sub-portions that are spaced at intervals,

fingers extending along the second direction and arranged at two sides of the busbars, wherein the fingers are connected to the sub-busbars, and

electrode pads sandwiched between the first sub-portions of the two sub-busbars and connected to the first sub-portions, wherein the first sub-portion of at least one of the sub-busbars protrude towards a side away from the electrode pads,

wherein connecting end portions are provided at two ends of each of the sub-busbars, the connecting end portions are connected to the first sub-portions, and

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- in the connecting end portions and the first sub-  
 portions that are connected, widths of the connecting  
 end portions in the second direction gradually  
 decrease along a direction from the first sub-portions  
 pointing to the connecting end portions; and/or  
 the connecting end portions are connected to the second  
 sub-portions, and in the connecting end portions and  
 the second sub-portions that are connected, widths of  
 the connecting end portions in the second direction  
 gradually decrease along a direction from the second  
 sub-portions pointing to the connecting end portions.
9. The solar cell according to claim 8, wherein along the  
 second direction, distances between the connecting end  
 portions of the two sub-busbars in one of the busbars are  
 equal.
10. The solar cell according to claim 9, wherein along the  
 second direction, the distances between the connecting end  
 portions of the two sub-busbars in one of the busbars range  
 from 0.5 mm to 3.0 mm.
11. The solar cell according to claim 8, wherein along the  
 second direction, widths of sides of the connecting end  
 portions away from the electrode pads are greater than or  
 equal to 0.1 mm, and widths of sides of the connecting end  
 portions close to the electrode pads are less than or equal to  
 2 mm.
12. The solar cell according to claim 8, wherein the two  
 sub-busbars of one of the busbars are symmetrically  
 arranged;  
 along the second direction, a maximum distance between  
 adjacent first sub-portions ranges from 1.2 mm to 1.8  
 mm, and  
 along the second direction, a distance between adjacent  
 second sub-portions ranges from 0.9 mm to 1.5 mm.
13. The solar cell according to claim 8, wherein along the  
 first direction, the electrode pads are in contact with the  
 sub-busbars, and a length of a contact region ranges from 0.5  
 mm to 5.0 mm.
14. The solar cell according to claim 8, wherein along the  
 second direction, widths of the sub-busbars range from 0.2  
 mm to 0.6 mm.
15. A photovoltaic module, comprising:  
 a transparent cover plate, an upper packaging layer, a  
 lower packaging layer, and a back plate, and at least one  
 solar cell, wherein the solar cell comprises:

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- a silicon wafer including an emitter layer on one side of  
 the silicon wafer;  
 a first passivation layer arranged on a side of the emitter  
 layer away from the silicon wafer;  
 a second passivation layer arranged on a side of the  
 silicon wafer away from the emitter layer; and  
 an electrode structure arranged on a side of the first  
 passivation layer away from the silicon wafer, and/or  
 arranged on a side of the second passivation layer  
 away from the silicon wafer,  
 wherein the electrode structure comprises:  
 busbars extending along a first direction and each  
 including two sub-busbars arranged opposite to  
 each other along a second direction intersecting  
 with the first direction, wherein each of the sub-  
 busbars includes first sub-portions and second  
 sub-portions that are spaced at intervals,  
 fingers extending along the second direction and  
 arranged at two sides of the busbars, wherein the  
 fingers are connected to the sub-busbars, and  
 electrode pads sandwiched between the first sub-  
 portions of the two sub-busbars and connected to  
 the first sub-portions, wherein the first sub-portion  
 of at least one of the sub-busbars protrude towards  
 a side away from the electrode pads,  
 wherein connecting end portions are provided at two  
 ends of each of the sub-busbars, the connecting  
 end portions are connected to the first sub-portion  
 of at least one of the sub-busbars, and in the connecting  
 end portions and the first sub-portions that are  
 connected, widths of the connecting end portions in  
 the second direction gradually decrease along a  
 direction from the first sub-portions pointing to the  
 connecting end portions; and/or  
 the connecting end portions are connected to the  
 second sub-portions, and in the connecting end  
 portions and the second sub-portions that are  
 connected, widths of the connecting end portions  
 in the second direction gradually decrease along a  
 direction from the second sub-portions pointing to  
 the connecting end portions.

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